



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Right Angle**

Connector System: **Board-to-Board**

Number of Positions: **34**

Number of Rows: **2**

## Features

### Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

### Configuration Features

PCB Mount Orientation	Right Angle
Number of Positions	34
Number of Rows	2
Board-to-Board Configuration	Perpendicular

### Body Features

Primary Product Color	Black
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### Contact Features

Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]
Contact Type	Pin



### Termination Features

Termination Method to Printed Circuit Board	Through Hole - Solder
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### Mechanical Attachment

Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

### Housing Features

Centerline (Pitch)	2 mm [.079 in]
Housing Material	PA 6T GF30

### Dimensions

Row-to-Row Spacing	2 mm [.079 in]
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### Usage Conditions

Operating Temperature Range	-40 – 105 °C [-40 – 221 °F]
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### Operation/Application

Circuit Application	Signal
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### Industry Standards

UL Flammability Rating	UL 94V-0
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### Product Compliance

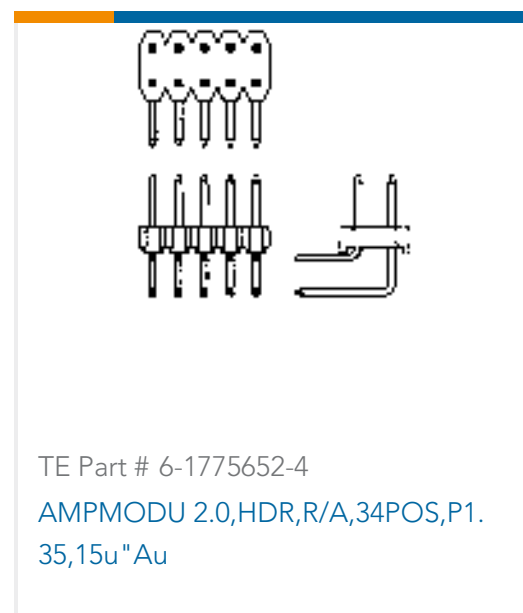
[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JUN 2018 (191) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

## Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts



## Customers Also Bought



## Documents

[CAD Files](#)
[3D PDF](#)
[3D](#)
[Customer View Model](#)



[ENG\\_CVM\\_CVM\\_6-1775653-4\\_B.2d\\_dxf.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_6-1775653-4\\_B.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_6-1775653-4\\_B.3d\\_stp.zip](#)

English

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## Product Specifications

[Product Specification](#)

English